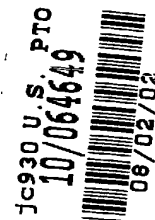


Electronic Filing System (EFS) Data  
Electronic Patent Application Submission  
USPTO Use Only

EFS ID: 16876  
Application ID: 10064649  
Title of Invention: SANDWICH PHOTORESIST  
STRUCTURE IN  
PHTOTLITHOGRAPHIC PROCESS  
First Named Inventor: BENJAMIN SZU-MIN LIN  
Domestic/Foreign Application: Domestic Application  
Filing Date: null  
Effective Receipt Date: 2002-08-02  
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Filing Type: new-utility  
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Attorney Docket Number: NONE  
Digital Certificate Holder: cn=Jiawei Huang, ou=Registered Attorneys, ou=Patent and  
Trademark Office, ou=Department of Commerce, o=U.S.  
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Total Fees Authorized: \$834.0  
Payment Category: DA - Deposit Account  
Deposit Account Number: 500710  
Deposit Account Name: jiawei



## TRANSMITTAL FORM



Electronic Version 1.0.3

Stylesheet Version: 1.0

Submission Type: Utility Patent Filing

# SANDWICH PHOTORESIST STRUCTURE IN PHTOTLITHOGRAPHIC PROCESS

First Named Inventor: BENJAMIN SZU-MIN LIN

## SUBMITTED BY

Name:	JIAWEI HUANG
Registration Number:	43330
Electronic Signature Mark: JH	Date Signed: 20020802

*I certify that the use of this system is for OFFICIAL correspondence between patent applicants or their representatives and the USPTO. Fraudulent or other use besides the filing of official correspondence by authorized parties is strictly prohibited, and subject to a fine and/or imprisonment under applicable law.*

*I, the undersigned, certify that I have viewed a display of document(s) being electronically submitted to the United States Patent and Trademark Office, using either the USPTO provided style sheet or software, and that this is the document(s) I intend for initiation or further prosecution of a patent application noted in the submission. This document(s) will become part of the official electronic record at the USPTO.*

## Attached Files:

declaration	8999Declaration1.tif
declaration	8999Declaration2.tif
fee-transmittal	JCLA8999_Afee.xml
bibd-transmittal	JCLA8999_Aapds.xml
specification	JCLA8999_A.xml

patent-assignments

JCLA8999\_Aasgn.xml

Attached Image File(s):

8999Declaration1.tif

8999Declaration2.tif



## COMBINED DECLARATION AND POWER OF ATTORNEY

As the below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name and that I believe I am an original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled

**SANDWICH PHOTORESIST STRUCTURE  
IN PHOTOLITHOGRAPHIC PROCESS**

the specification of which

  X   is attached hereto.

       was filed on                                 

as Application Serial No.                                  and was amended on                                 .

I hereby state that I have reviewed and understand the contents of the above-identified specification, including the claims, as amended by any amendment referred to above.

I acknowledge the duty to disclose information which is material to the patentability of this application in accordance with Title 37, Code of Federal Regulations, § 1.56(a).

I hereby claim foreign priority benefits under Title 35, United States Code, § 119 of any foreign application(s) for patent or inventor's certificate listed below and have also identified below any foreign application for patent or inventor's certificate having a filing date before that of the application on which priority is claimed:

Prior Foreign Application(s):

Number	Country	Date Filed(yyyy/mm/dd)	Yes	No
91115384	Taiwan, R.O.C.	2002/7/11	X	

I hereby appoint the following attorney(s) and/or agent(s) to prosecute this application and to transact all business in the Patent and Trademark Office connected therewith:

<b>Belinda Lee</b>	<b>(Reg. No. 46,863)</b>	<b>Marrina Mei</b>	<b>(Reg. No. 44,935)</b>
<b>Jiawei Huang</b>	<b>(Reg. No. 43,330)</b>		
<b>Charles C.H. Wu</b>	<b>(Reg. No. 39,081)</b>		

SEND CORRESPONDENCE TO:

DIRECT TELEPHONE CALLS TO:  
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Taipei 100, Taiwan, R.O.C.  
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FAX: 886-2-2369 7233

**Belinda Lee**

## COMBINED DECLARATION AND POWER OF ATTORNEY CONTINUED

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patents issued thereon.

Benjamin S.M. Lin  
Signature

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Date

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# FEE TRANSMITTAL

Electronic Version 1.1.0

Stylesheet Version: 1.0

*Patent fees are subject to annual revisions on or about October 1st of each year.*

Large Entity

**TOTAL FEES AUTHORIZED: \$ 834**

The commissioner is hereby authorized to charge indicated processing and/or publication fees and credit any overpayments to:

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Charge Any Additional Fee Required Under 37 C.F.R. Sections 1.16 and 1.17.

Charge Assignment Fees Required Under 37 C.F.R. Section 1.21 (h).

## SUBMITTED BY

Authorized Name: jiawei  
Electronic Signature Mark: jiawei  
Date Signed: 20020802

## BASIC FILING FEE

Fee Description	Fee Code	Fee Paid
Utility Filing Fee	101	\$ 740

Subtotal For Basic Filing Fee: \$ 740

## EXTRA CLAIM FEES

	Fee Code	Fee	Extra Claims	Fee Paid
Total Claims: 23	103	\$ 18	3	\$ 54
Independent Claims: 3	102	\$ 84	0	\$ 0

10064649 - 00000000

Subtotal For Extra Claims Fees: \$ 54

ADDITIONAL FEES

Fee Description	Number	Quantity	Fee Code	Amount	Fee Paid
Recording Each Patent Assignment Per Property Fee	00000000	1	581	\$ 40	\$ 40

Subtotal For Additional Fees: \$ 40